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C8051F55x/56x/57x

Mixed Signal ISP Flash MCU Family

Analog Peripherals
- **12-Bit ADC**
  - Up to 200 ksps
  - Up to 32 external single-ended inputs
  - VREF from on-chip VREF, external pin or V_{DD}
  - Internal or external start of conversion source
  - Built-in temperature sensor
- **Two Comparators**
  - Programmable hysteresis and response time
  - Configurable as interrupt or reset source
  - Low current

On-Chip Debug
- On-chip debug circuitry facilitates full speed, non-intrusive in-system debug (no emulator required)
- Provides breakpoints, single stepping, inspect/modify memory and registers
- Superior performance to emulation systems using ICE-chips, target pods, and sockets
- Low cost, complete development kit

Supply Voltage 1.8 to 5.25 V
- Typical operating current: 19 mA at 50 MHz
- Typical stop mode current: 1 µA

High-Speed 8051 µC Core
- Pipelined instruction architecture; executes 70% of instructions in 1 or 2 system clocks
- Up to 50 MIPS throughput with 50 MHz clock
- Expanded interrupt handler

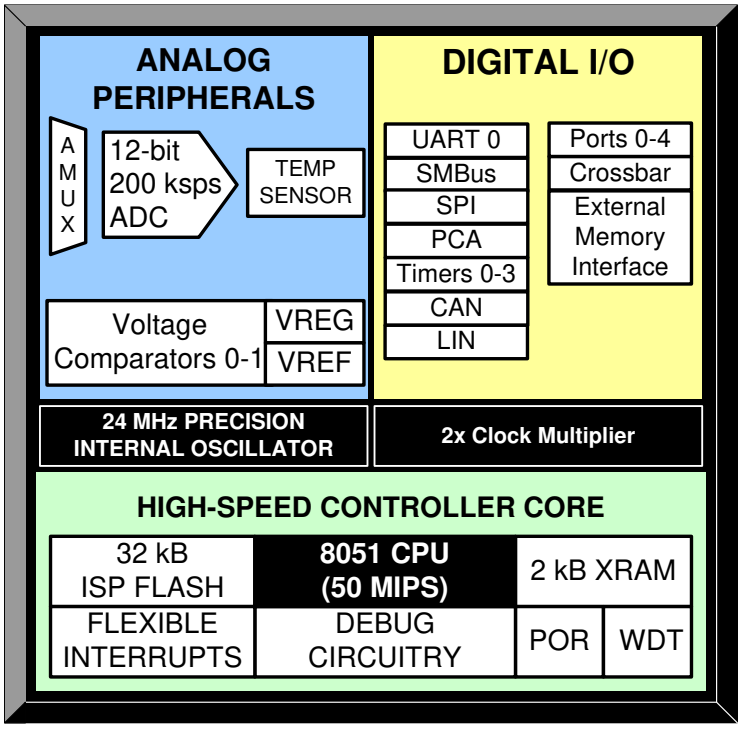
Memory
- 2304 bytes internal data RAM (256 + 2048 XRAM)
- 32 or 16 kB Flash; In-system programmable in 512-byte Sectors

Digital Peripherals
- 33, 25, or 18 Port I/O; All 5 V tolerant
- CAN 2.0 Controller—no crystal required
- LIN 2.1 Controller (Master and Slave capable); no crystal required
- Hardware enhanced UART, SMBus™, and enhanced SPI™ serial ports
- Four general purpose 16-bit counter/timers
- 16-bit programmable counter array (PCA) with six capture/compare modules and enhanced PWM functionality

Clock Sources
- Internal 24 MHz with ±0.5% accuracy for CAN and master LIN operation
- External oscillator: Crystal, RC, C, or clock (1 or 2 pin modes)
- Can switch between clock sources on-the-fly; useful in power saving modes

Packages
- 40-pin QFN (C8051F568-9 and ‘F570-5)
- 32-pin QFP/QFN (C8051F560-7)
- 24-pin QFN (C8051F550-7)

Automotive Qualified
- Temperature Range: –40 to +125 °C
- Compliant to AEC-Q100



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1. System Overview

C8051F55x/56x/57x devices are fully integrated mixed-signal System-on-a-Chip MCUs. Highlighted features are listed below. Refer to Table 2.1 for specific product feature selection and part ordering numbers.

- High-speed pipelined 8051-compatible microcontroller core (up to 50 MIPS)
- In-system, full-speed, non-intrusive debug interface (on-chip)
- Controller Area Network (CAN 2.0B) Controller with 32 message objects, each with its own indentifier mask (C8051F550/1/4/5, ‘F560/1/4/5/8/9, and ‘F572/3)
- LIN 2.1 peripheral (fully backwards compatible, master and slave modes) (C8051F550/2/4/6, ‘F560/2/4/6/8, and ‘F570/2/4)
- True 12-bit 200 ksps 32-channel single-ended ADC with analog multiplexer
- Precision programmable 24 MHz internal oscillator that is within ±0.5% across the temperature range and for VDD voltages greater than or equal to the on-chip voltage regulator minimum output at the low setting. The oscillator is within ±1.0% for VDD voltages below this minimum output setting.
- On-chip Clock Multiplier to reach up to 50 MHz
- 32 kB (C8051F550-3, ‘F560-3, ‘F568-9, and ‘F570-1) or 16 kB (C8051F554-7, ‘F564-7, and ‘F572-5) of on-chip Flash memory
- 2304 bytes of on-chip RAM
- SMBus/I2C, Enhanced UART, and Enhanced SPI serial interfaces implemented in hardware
- Four general-purpose 16-bit timers
- External Data Memory Interface (C8051F568-9 and ‘F570-5) with 64 kB address space
- Programmable Counter/Timer Array (PCA) with six capture/compare modules and Watchdog Timer function
- On-chip Voltage Regulator
- On-chip Power-On Reset, V_{DD} Monitor, and Temperature Sensor
- On-chip Voltage Comparator
- 33, 25, or 18 Port I/O (5 V push-pull)

With on-chip Voltage Regulator, Power-On Reset, V_{DD} monitor, Watchdog Timer, and clock oscillator, the C8051F55x/56x/57x devices are truly stand-alone System-on-a-Chip solutions. The Flash memory can be reprogrammed even in-circuit, providing non-volatile data storage, and also allowing field upgrades of the 8051 firmware. User software has complete control of all peripherals, and may individually shut down any or all peripherals for power savings.

The on-chip Silicon Labs 2-Wire (C2) Development Interface allows non-intrusive (uses no on-chip resources), full speed, in-circuit debugging using the production MCU installed in the final application. This debug logic supports inspection and modification of memory and registers, setting breakpoints, single stepping, run and halt commands. All analog and digital peripherals are fully functional while debugging using C2. The two C2 interface pins can be shared with user functions, allowing in-system debugging without occupying package pins.

The devices are specified for 1.8 V to 5.25 V operation over the automotive temperature range (–40 to +125 °C). The C8051F568-9 and ‘F570-5 are available in 40-pin QFN packages, the C8051F560-7 devices are available in 32-pin QFP and QFN packages, and the C8051F550-7 are available in 24-pin QFN packages. All package options are lead-free and RoHS compliant. See Table 2.1 for ordering information. Block diagrams are included in Figure 1.1, Figure 1.2, and Figure 1.3.

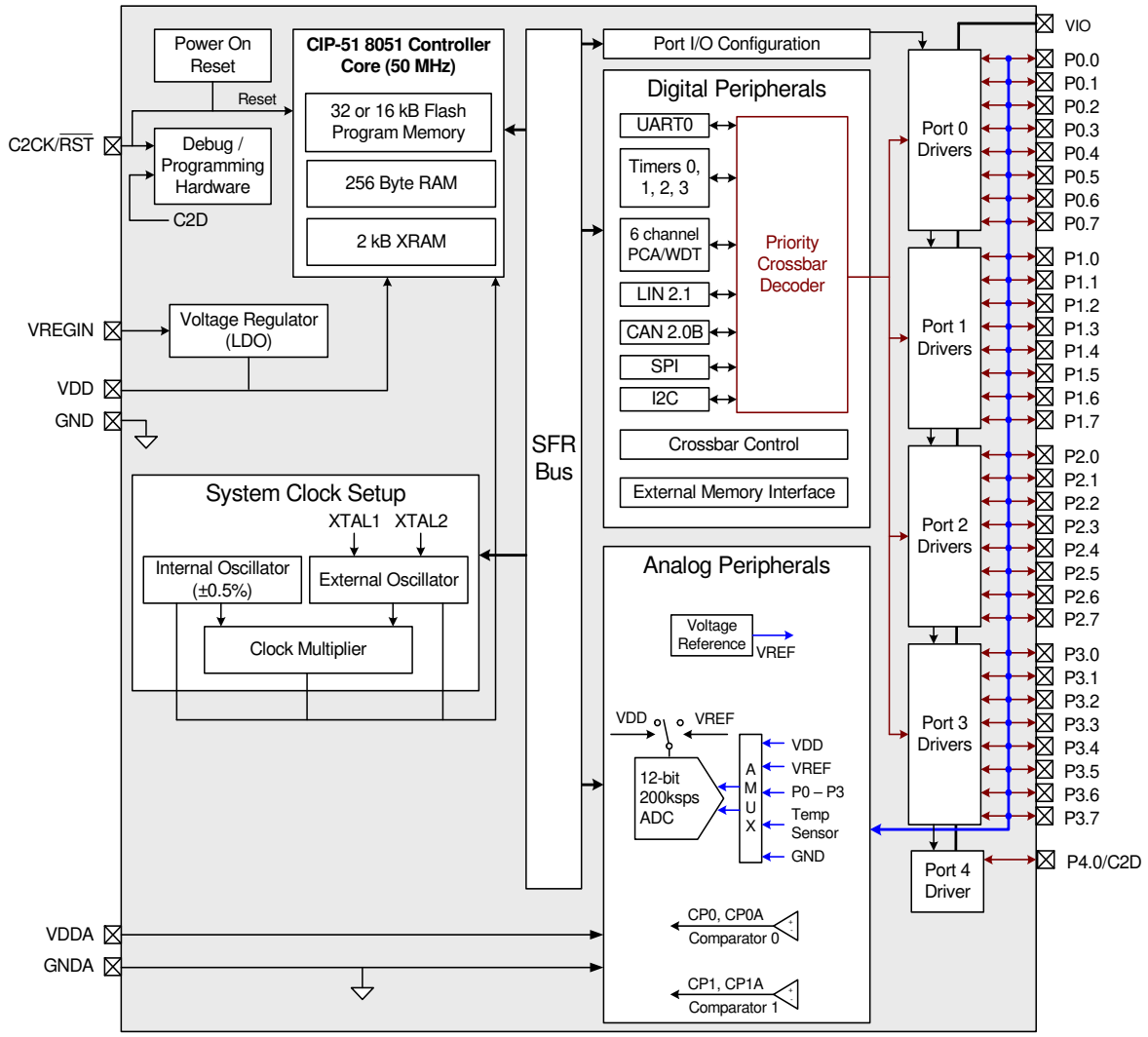

Figure 1.1. C8051F568-9 and 'F570-5 (40-pin) Block Diagram

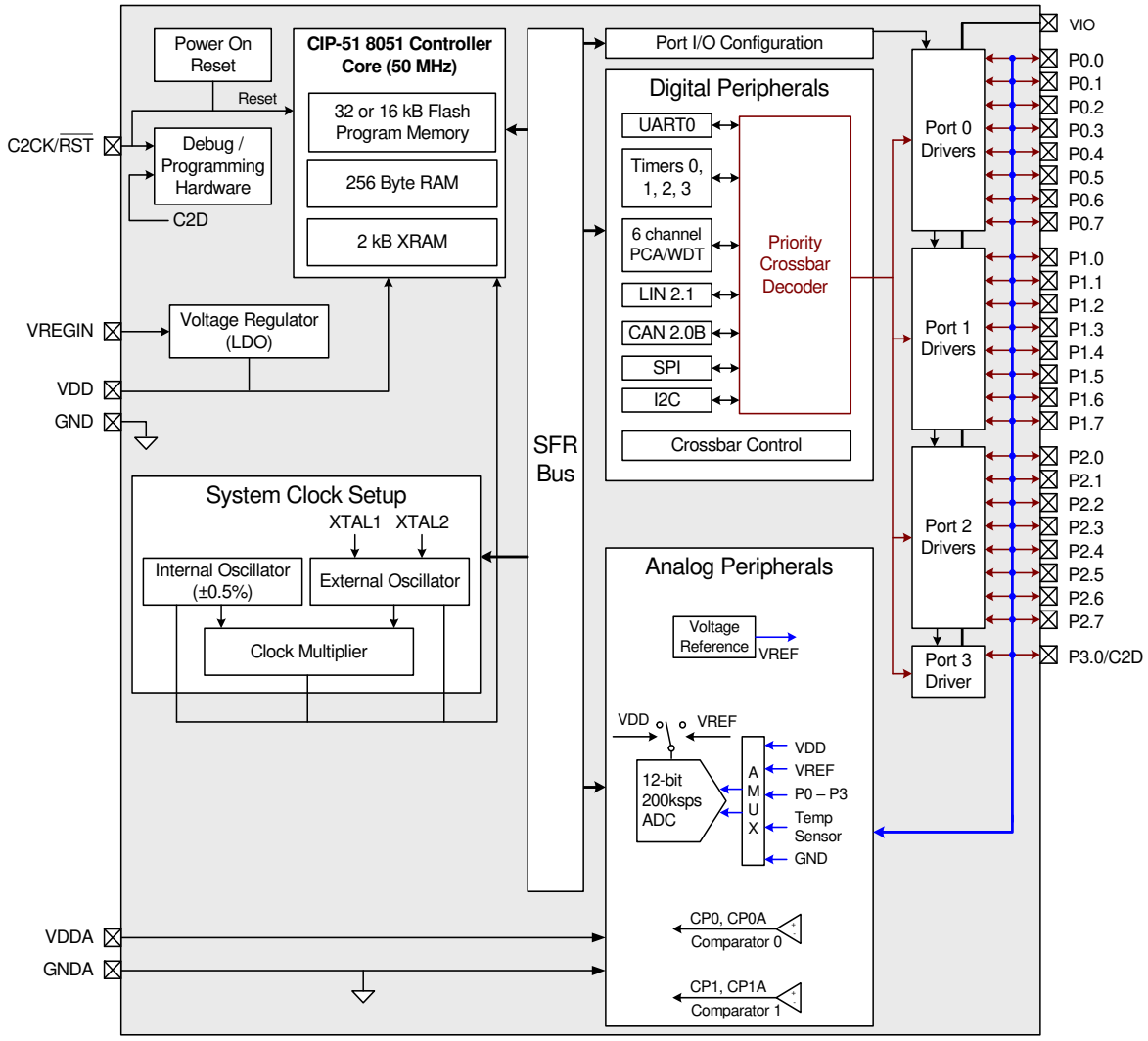

Figure 1.2. C8051F560-7 (32-pin) Block Diagram

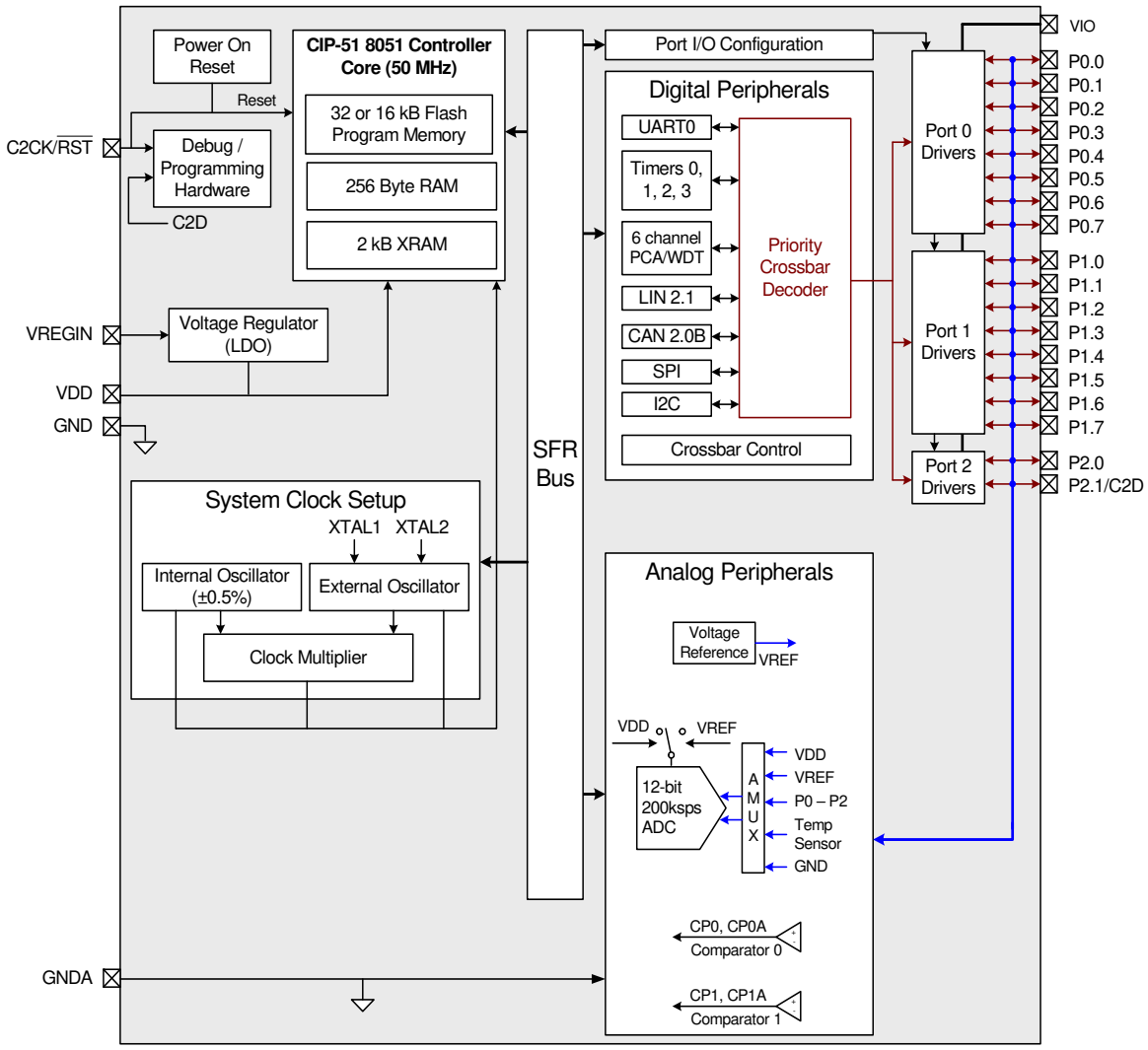

Figure 1.3. C8051F550-7 (24-pin) Block Diagram

2. Ordering Information

The following features are common to all devices in this family:

- 50 MHz system clock and 50 MIPS throughput (peak)
- 2304 bytes of RAM (256 internal bytes and 2048 XRAM bytes)
- SMBus/I^2C, Enhanced SPI, Enhanced UART
- Four Timers
- Six Programmable Counter Array channels
- Internal 24 MHz oscillator
- Internal Voltage Regulator
- 12-bit, 200 ksps ADC
- Internal Voltage Reference and Temperature Sensor
- Two Analog Comparators

Table 2.1 shows the feature that differentiate the devices in this family.

Table 2.1. Product Selection Guide

Ordering Part Number	Flash Memory (kB)	CAN2.0B	LIN2.1	Digital Port I/Os	External Mem. Interface	Package
C8051F550-IM	32	✓	✓	18	—	QFN-24
C8051F551-IM	32	✓	—	18	—	QFN-24
C8051F552-IM	32	—	✓	18	—	QFN-24
C8051F553-IM	32	—	—	18	—	QFN-24
C8051F554-IM	16	✓	✓	18	—	QFN-24
C8051F555-IM	16	✓	—	18	—	QFN-24
C8051F556-IM	16	—	✓	18	—	QFN-24
C8051F557-IM	16	—	—	18	—	QFN-24
C8051F560-IM	32	✓	✓	25	—	QFN-32
C8051F560-IQ	32	✓	✓	25	—	QFP-32
C8051F561-IM	32	✓	—	25	—	QFN-32
C8051F561-IQ	32	✓	—	25	—	QFP-32
C8051F562-IM	32	—	✓	25	—	QFN-32
C8051F562-IQ	32	—	✓	25	—	QFP-32
C8051F563-IM	32	—	—	25	—	QFN-32
C8051F563-IQ	32	—	—	25	—	QFP-32

Ordering Part Number	Flash Memory (kB)	CAN2.0B	LIN2.1	Digital Port I/Os	External Mem. Interface	Package
C8051F564-IM	16	✓	✓	25	—	QFN-32
C8051F564-IQ	16	✓	✓	25	—	QFP-32
C8051F565-IM	16	✓	—	25	—	QFN-32
C8051F565-IQ	16	✓	—	25	—	QFP-32
C8051F566-IM	16	—	✓	25	—	QFN-32
C8051F566-IQ	16	—	✓	25	—	QFP-32
C8051F567-IM	16	—	—	25	—	QFN-32
C8051F567-IQ	16	—	—	25	—	QFP-32
C8051F568-IM	32	✓	✓	33	✓	QFN-40
C8051F569-IM	32	✓	—	33	✓	QFN-40
C8051F570-IM	32	—	✓	33	✓	QFN-40
C8051F571-IM	32	—	—	33	✓	QFN-40
C8051F572-IM	16	✓	✓	33	✓	QFN-40
C8051F573-IM	16	✓	—	33	✓	QFN-40
C8051F574-IM	16	—	✓	33	✓	QFN-40
C8051F575-IM	16	—	—	33	✓	QFN-40

Note: The suffix of the part number indicates the device rating and the package. All devices are RoHS compliant.

All devices in Table 2.1 are also available in an automotive version. For the automotive version, the -I in the ordering part number is replaced with -A. For example, the automotive version of the C8051F550-IM is the C8051F550-AM.

The -AM and -AQ devices receive full automotive quality production status, including AEC-Q100 qualification, registration with International Material Data System (IMDS) and Part Production Approval Process (PPAP) documentation. PPAP documentation is available at www.silabs.com with a registered and NDA approved user account. The -AM and -AQ devices enable high volume automotive OEM applications with their enhanced testing and processing. Please contact Silicon Labs sales for more information regarding –AM and -AQ devices for your automotive project.

3. Pin Definitions

Table 3.1. Pin Definitions for the C8051F55x/56x/57x

Name	Pin 40-pin packages	Pin 32-pin packages	Pin 24-pin packages	Type	Description
VDD	4	4	3		Digital Supply Voltage. Must be connected.
GND	6	6	4		Digital Ground. Must be connected.
VDDA	5	5	—		Analog Supply Voltage. Must be connected.
GNDA	7	7	5		Analog Ground. Must be connected.
VREGIN	3	3	2		Voltage Regulator Input
VIO	2	2	1		Port I/O Supply Voltage. Must be connected.
$\overline{\text{RST}}$/ C2CK	10	10	8	D I/O D I/O	Device Reset. Open-drain output of internal POR or V_{DD} Monitor. Clock signal for the C2 Debug Interface.
P4.0/ C2D	9	—	—	D I/O or A In D I/O	Port 4.0. See SFR Definition 19.28. Bi-directional data signal for the C2 Debug Interface.
P3.0/ C2D		9	—	D I/O or A In D I/O	Port 3.0. See SFR Definition 19.24. Bi-directional data signal for the C2 Debug Interface.
P2.1/ C2D		—	7	D I/O or A In D I/O	Port 2.1. See SFR Definition 19.20. Bi-directional data signal for the C2 Debug Interface.
P0.0	8	8	6	D I/O or A In	Port 0.0. See SFR Definition 19.12.
P0.1	1	1	24	D I/O or A In	Port 0.1
P0.2	40	32	23	D I/O or A In	Port 0.2
P0.3	39	31	22	D I/O or A In	Port 0.3
P0.4	38	30	21	D I/O or A In	Port 0.4
P0.5	37	29	20	D I/O or A In	Port 0.5
P0.6	36	28	19	D I/O or A In	Port 0.6
P0.7	35	27	18	D I/O or A In	Port 0.7

Table 3.1. Pin Definitions for the C8051F55x/56x/57x (Continued)

Name	Pin 40-pin packages	Pin 32-pin packages	Pin 24-pin packages	Type	Description
P1.0	34	26	17	D I/O or A In	Port 1.0. See SFR Definition 19.16.
P1.1	33	25	16	D I/O or A In	Port 1.1.
P1.2	32	24	15	D I/O or A In	Port 1.2.
P1.3	31	23	14	D I/O or A In	Port 1.3.
P1.4	30	22	13	D I/O or A In	Port 1.4.
P1.5	29	21	12	D I/O or A In	Port 1.5.
P1.6	28	20	11	D I/O or A In	Port 1.6.
P1.7	27	19	10	D I/O or A In	Port 1.7.
P2.0	26	18	9	D I/O or A In	Port 2.0. See SFR Definition 19.20.
P2.1	25	17	—	D I/O or A In	Port 2.1.
P2.2	24	16	—	D I/O or A In	Port 2.2.
P2.3	23	15	—	D I/O or A In	Port 2.3.
P2.4	22	14	—	D I/O or A In	Port 2.4.
P2.5	21	13	—	D I/O or A In	Port 2.5.
P2.6	20	12	—	D I/O or A In	Port 2.6.
P2.7	19	11	—	D I/O or A In	Port 2.7.
P3.0	18	—	—	D I/O or A In	Port 3.0. See SFR Definition 19.24.
P3.1	17	—	—	D I/O or A In	Port 3.1.
P3.2	16	—	—	D I/O or A In	Port 3.2.
P3.3	15	—	—	D I/O or A In	Port 3.3.
P3.4	14	—	—	D I/O or A In	Port 3.4.
P3.5	13	—	—	D I/O or A In	Port 3.5.
P3.6	12	—	—	D I/O or A In	Port 3.6.
P3.7	11	—	—	D I/O or A In	Port 3.7.

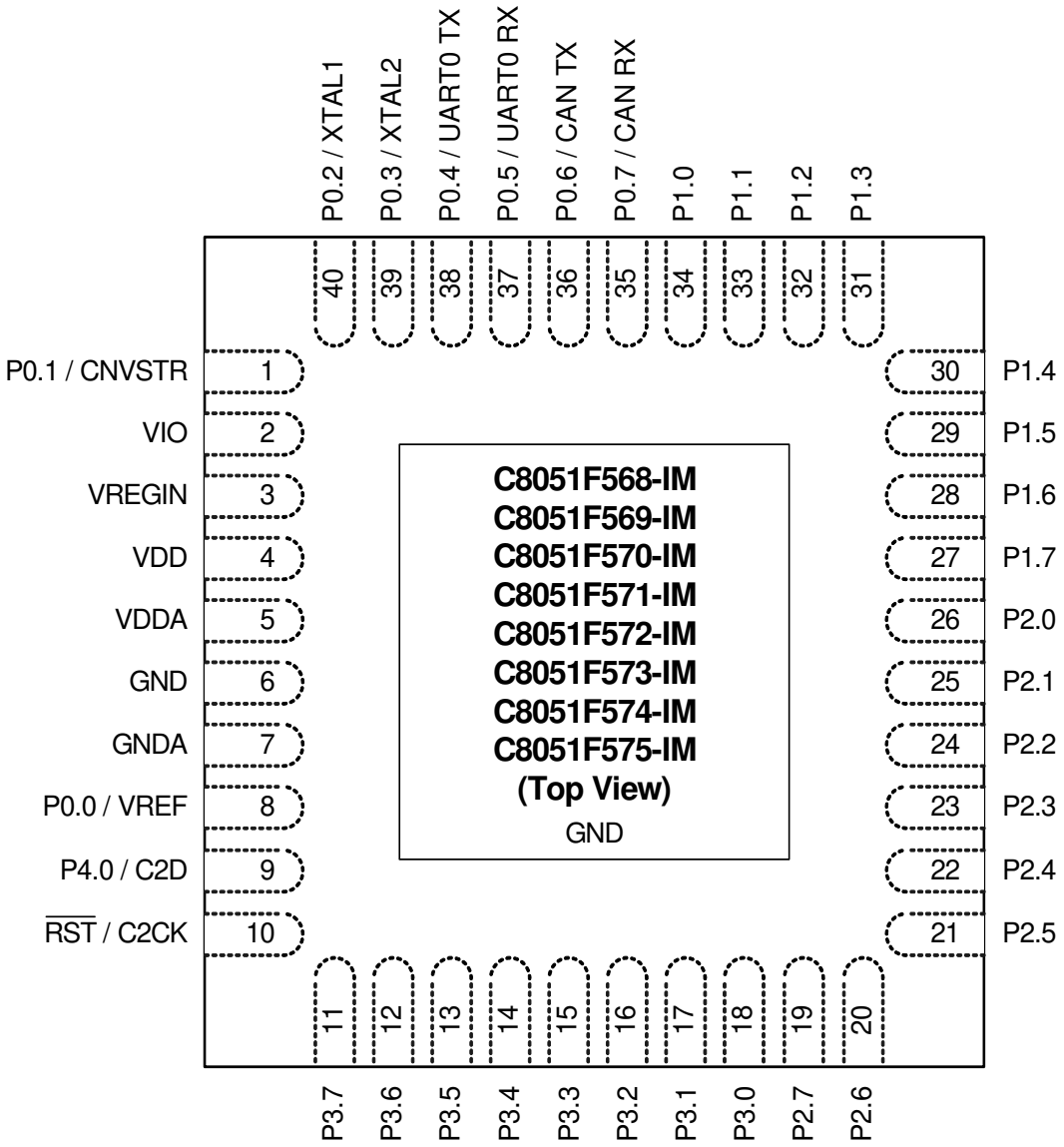

Figure 3.1. QFN-40 Pinout Diagram (Top View)

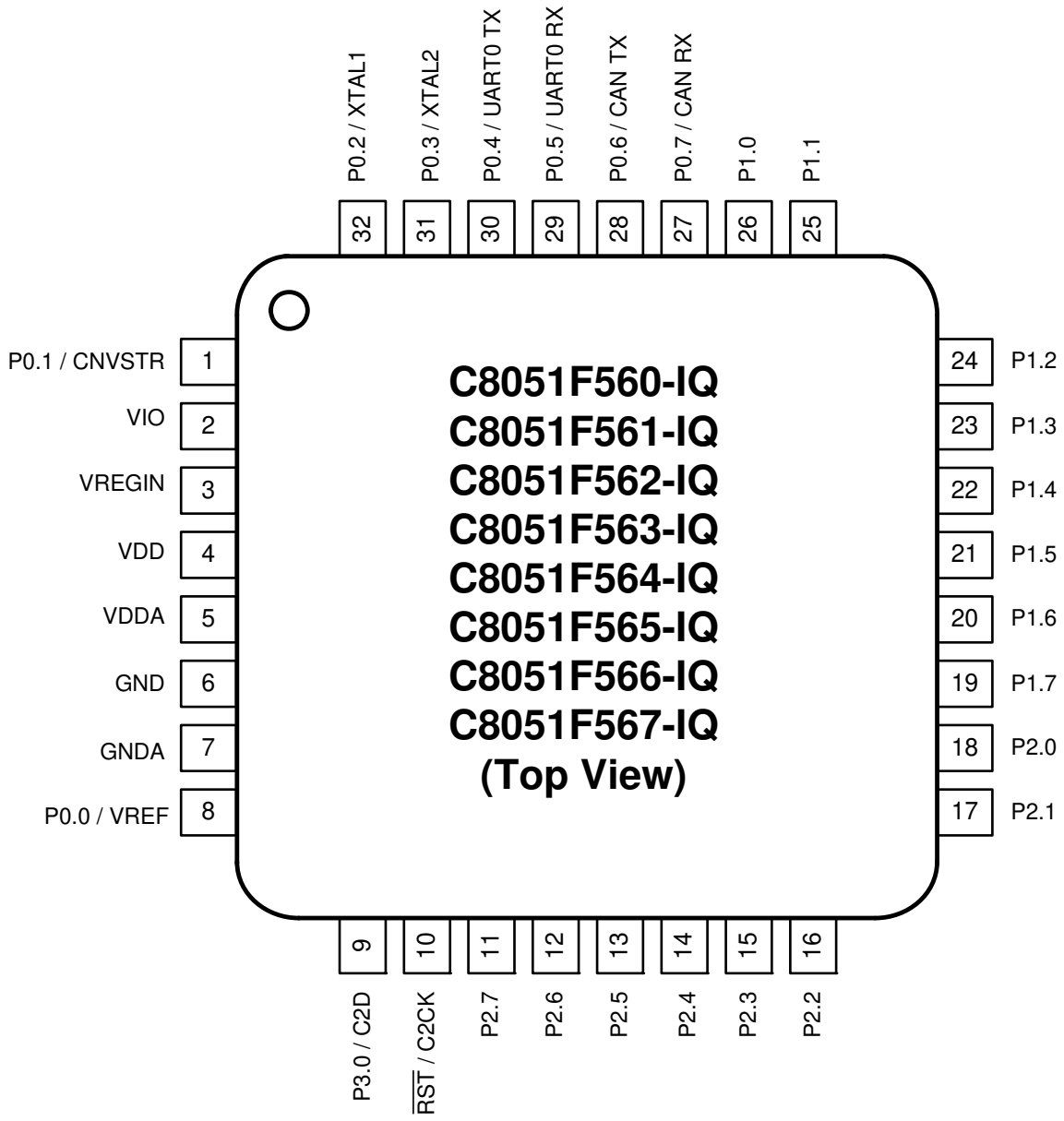

Figure 3.2. QFP-32 Pinout Diagram (Top View)